MATERIAL SAFETY DATA SHEET

Battery chargers are exempt articles and are not subject to the OSHA Hazard Communication Standard Requirement. This sheet is only provided as technical information and is referred normal use of the product in question. Zeus makes no warranty expressed or implied.

SECTION 1 - Product and Company Identification

Product Name: Sealed Lead Acid Charger PCCG-SLA6VXXXX	**Sizes:** 6V
Company: PowerCell LLC dba ZEUS Battery Products	**Telephone Number:** +1 (630) 295-6800
Address: 191 Covington Dr. Bloomingdale, IL 60108 USA	**Fax Number:** +1 (630) 295-6801
	Date of Preparation: June 18th, 2019

SECTION 2 - Product Information

Material	Material / Total Weight	Name of Material	Chemical Name	Chemical Registration No./CAS No.	Material Weight (g)	Ingredients (%)
PCB board	7.67	EPOXY	$(C_{11}H_{12}O_3)n$	61788-97-4	0.20111	1.70%
		HEMA	$C_6H_{10}O_3$	868-77-9	0.10174	0.86%
		titanium dioxide	$H_2O_{12}Mg_3Si_4$	14807-96-6	0.11830	1.00%
		titanium dioxide	TiO_2	13463-67-7	0.05915	0.50%
		phenolic resin	C_6H_6O	108-95-2	4.34161	36.70%
		Fiber paper	$C_{12}H_{22}O_{11}$	9004-34-6	4.96860	42.00%
		copper foil	Cu	7440-50-8	1.53790	13.00%
PE bag	2.2	polyethylene	C_2H_4	9002-88-4	3.10000	100.00%
Transformer	4.342	skeleton	Phenolic-Fromaldehyde Resin	9003-35-4	0.36900	45.00%
			Wood Flour	9004-34-6	0.16400	20.00%
			Calcium Carbonate	471-34-1	0.24600	30.00%
			Hexamethylene Tetraamine	100-97-0	0.03280	4.00%
			Black Pigment	1333-86-4	0.00492	0.60%
			Phenol (C_6H_5OH)	108-95-2	0.00328	0.40%
		magnetic core	FeO_3	1309-37-1	1.79200	70.00%
			MnO	1309-37-1	0.51200	20.00%
			ZnO	1314-13-2	0.25600	10.00%
		copper wire	Cu	7440-50-8	0.56318	97.10%
			insulating resin	01330-20-07	0.01682	2.90%

N/A = Not Applicable

Material	Material / Total Weight	Name of Material	Chemical Name	Chemical Registration No./CAS No.	Material Weight (g)	Ingredients (%)
Transformer	4.342	stitch	Cu	7440-50-8	0.11760	84.00%
			Fe	7439-89-6	0.01330	9.50%
			Sn	7440-31-5	0.00910	6.50%
		TLW-B	Cu	7440-50-8	0.26970	93.00%
			Polyethylene Terephthalate	86630-59-3	0.01450	5.00%
			PA poly amide	187235-53-6	0.00580	2.00%
		packaging tape	PET FILM	25038-59-9	0.02025	45.00%
			2-EHA	29590-42-9	0.01125	25.00%
			$C_{11}H_{20}O_2$	103-11-7		
			$C_7H_{12}O_2$	141-32-2	0.00540	12.00%
			$ZnSO_4$	7733-02-0	0.00270	6.00%
			TiO_2	13463-67-7	0.00090	2.00%
			FR-308	20208-95-1	0.00441	9.80%
			Pigment Yellow, etc.	71832-85-4	0.00009	0.20%
		Lead-free solder article	Sn	7440-31-5	0.03200	99.99%
			Ag	7440-22-4	0.00000	0.00%
			Sb	7440-36-0	0.00000	0.00%
			Bi	7440-69-9	0.00000	0.00%
			Cu	7440-50-8	0.00000	0.00%
			Pb	7439-92-1	0.00000	0.00%
			Zn	7440-66-6	0.00000	0.00%
			Fe	7439-89-6	0.00000	0.00%
			Al	7429-90-5	0.00000	0.00%
			As	7440-38-2	0.00000	0.00%
			Cd	7440-43-9	0.00000	0.00%
		electric insulating oil	Methyl acrylate	96-33-3	0.01013	67.50%
			Dimethyl benzene	1330-20-7	0.00405	27.00%
			butyl acetate	123-86-4	0.00045	3.00%
			butan-1-ol	71-36-3	0.00030	2.00%
		diluent	1, 2-xylene; o-xylene	95-47-6	0.00960	80.00%
			Cyclohexanone	108-94-1	0.00060	5.00%
			butyl alcohol; 1-butanol	71-36-3	0.00180	15.00%
		scaling powder	Isopropanol	67-63-0	0.01091	90.90%
			Hydrogenated rosin	65997-06-0	0.00048	4.00%
			cyclohexanamine, hydrobromide	26227-54-3	0.00019	1.60%
			Dipropylene glycol monomethyl ether	34590-94-8	0.00036	3.00%

Material	Material / Total Weight	Name of Material	Chemical Name	Chemical Registration No./CAS No.	Material Weight (g)	Ingredients (%)
Aluminum electrolytic capacitor	0.126	Is foil	Al	7429-90-5	0.01540	99.99%
			Fe	7439-89-6	0.00000	0.00%
			Si	7440-21-3	0.00000	0.00%
			Cu	7440-50-8	0.00000	0.00%
		Guide pin	Al	7429-90-5	0.00516	30.00%
			Fe	7439-89-6	0.00843	49.00%
			Cu	7440-50-8	0.00241	14.00%
			Sn	7440-31-5	0.00120	7.00%
		Electrolyte	Ethylene glycol	107-21-1	0.00840	60.00%
			Ammonium adipate	19090-60-9	0.00560	40.00%
		Aluminum case	Al	7429-90-5	0.01577	99.82%
			Fe	7439-89-6	0.00002	0.12%
			Si	7440-21-3	0.00001	0.06%
		colloidal particle	Butyl	9010-85-9	0.00571	35.00%
			ethene, (5E)-5-ethylidenebicyclo [2.2.1] hept-2-ene, prop-1-ene	25038-36-2	0.00571	35.00%
			carbon black	1333-86-4	0.00293	18.00%
			clay	1332-58-7	0.00619	38.00%
			SiO_2	14808-60-7	0.00114	7.00%
			Zinc oxide	1314-13-2	0.00033	2.00%
		Drivepipe	pet	29154-49-2	0.00954	90.00%
			Stability	31570-04-4	0.00002	0.20%
			lubricant	124-26-5	0.00002	0.15%
			pigment	1333-86-4	0.00011	1.00%
			butadiene	9003-17-2	0.00092	8.65%
		electrolytic paper	Cellulose	9004-34-6	0.01680	100.00%
		Negative Foil	Al	7429-90-5	0.01382	98.00%
			Fe	7439-89-6	0.00007	0.50%
			Si	7440-21-3	0.00003	0.20%
			Cu	7440-50-8	0.00003	0.20%
			Mn	7439-96-5	0.00016	1.10%
		Printing ink	Titanium dioxide	13463-67-7	0.00006	60.00%
			Polyester resin	109-16-0	0.00004	40.00%
Schottky diode	0.0083	Chip	Silicon	7440-21-3	0.00035	99.30%
			Phosphorus	7723-14-0	0.00000	0.01%
			Boron	7440-42-8	0.00000	0.01%
			Nickel	7440-02-0	0.00000	0.07%
		Copper wire	Iron	7739-89-6	0.00000	0.02%
			Phosphorus	7723-14-0	0.00000	0.01%
			Copper	7440-50-8	0.00557	99.98%
		soldering lug	Lead	7439-92-1	0.00017	92.50%
			Tin	7440-31-5	0.00001	5.00%
			Silver	7440-22-4	0.00000	2.50%

Material	Material / Total Weight	Name of Material	Chemical Name	Chemical Registration No./CAS No.	Material Weight (g)	Ingredients (%)
Schottky diode	0.0083	Printing ink	Polymer A	60676-86-0	0.00000	80.00%
			Polymer B	9003-35-4	0.00000	5.00%
			Pigment Al	1333-86-4	0.00000	0.50%
			Acrylic monomers	29690-82-2	0.00000	10.00%
		Tinplating	Tin	7440-31-5	0.00029	99.99%
			Lead	7439-92-1	0.00000	0.00%
			Iron	7439-89-6	0.00000	0.00%
			Copper	7440-50-8	0.00000	0.00%
		epoxy resin	Silicon dioxide	14808-60-7	0.00036	17.06%
			Quartz	7631-86-9	0.00018	8.53%
			Epoxy resin	61788-97-4	0.00012	5.80%
			FlameReterd and zb	9003-35-4	0.00005	2.39%
			Phenolic Resin	12536-65-1	0.00000	0.17%
			Carbom Black	1333-86-4	0.00000	0.17%
Chip resistor	0.002	Alumina Substrate	Al_2O_3	1344-28-1	0.00171	85.563%
			SiO_2	14808-60-7	0.00004	1.860%
			MgO	1309-48-4	0.00002	0.974%
			CaO	1305-78-8	0.00000	0.177%
		Protective Coating (G1)	Bi_2O_3	1304-76-3	0.00000	0.214%
			SiO_2	14808-60-7	0.00000	0.089%
			Cr_2O_3	1308-38-9	0.00000	0.053%
		Protective Coating (G2)	Epoxy resin	25068-38-6	0.00001	0.664%
			Silica	60676-86-0	0.00001	0.738%
			Talcum	14807-96-6	0.00000	0.074%
		Resistive Element	RuO_2	12036-10-1	0.00000	0.091%
			PbO	1317-36-8	0.00000	0.240%
			SiO_2	14808-60-7	0.00000	0.096%
			B_2O_3	1303-86-2	0.00000	0.034%
			Al_2O_3	1344-28-1	0.00000	0.096%
			ZnO	1314-13-2	0.00000	0.015%
		Termination (Inner) C1	Ag	7440-22-4	0.00003	1.472%
		Termination (Inner) C2	Ag	7440-22-4	0.00001	0.491%
			Pd	7440/5/3	0.00000	0.028%
			Glass	65997-18-4	0.00000	0.084%
		Termination (Inner) C3	Ni	7440-02-0	0.00001	0.437%
			Cr	7440-47-3	0.00000	0.109%
		Termination (Between) Ni Plating	Ni	7440-02-0	0.00006	3.179%
		Termination (Outer) Sn Plating	Sn	7440-31-5	0.00006	3.130%
		M/K	Epoxy resin	25068-38-6	0.00000	0.046%
			Fillier	13463-67-7	0.00000	0.028%
			Pigment	7727-43-7	0.00000	0.018%

N/A = Not Applicable

Material	Material / Total Weight	Name of Material	Chemical Name	Chemical Registration No./CAS No.	Material Weight (g)	Ingredients (%)
IC	0.12	Chip	Si	7440-21-3	0.00893	7.44%
		lead	Cu	7440-50-8	0.03802	31.68%
			Fe	7439-89-6	0.00002	0.02%
			Pb	7439-92-1	0.00001	0.01%
			P	7723-14-0	0.00001	0.01%
			Ni	7440-02-0	0.00154	1.28%
			Mg	7439-95-4	0.00013	0.11%
		External lead (electroplating)	Sn	7440-31-5	0.00182	1.52%
		epoxy resin	$(C_6H_6O \cdot CH_2O)$ x	9003-35-4	0.00318	2.65%
			$C_5H_4N_2O_3$	29690-82-2	0.00360	3.0%
		gold wire	Au	7440-57-5	0.00014	0.12%
		The model material	SiO_2	60676-86-0	0.05760	48.0%
			$(C_8H_8O_2)n$	9003-35-4	0.00184	1.53%
			Bi_2O_3	1304-76-3	0.00065	0.54%
			$C_{11}H_{15}ClO_3$	29690-82-2	0.00253	2.11%
Solid-state capacitor	0.72	anode foil	Al	7429-90-5	0.06905	9.59%
		cathod foil	Al	7429-90-5	0.05263	7.31%
		Lead	Fe	7439-89-6	0.14206	19.73%
			Cu	7440-50-8		
			Al	7429-90-5		
		Ink	resin	109-16-0	0.00360	0.50%
			Titanium Dioxide	13463-67-7		
			Cyclohexanone	108-94-1		
			Silicon dioxide	60676-86-0		
		Electrolytic Capacitor Paper	Manila Espartos	9004-34-6	0.07279	10.11%
		AL Case	Al	7929-90-5	0.08482	11.78%
			epoxide resin	14808-60-7		
		Oxidant	For toluene sulfonic acid	77214-82-5	0.00000	13.40%
		Monomer	3, 4-ethylenedioxythiophene	126213-50-1	0.00000	12.34%
		Rubber Hermetic Part	Butyl rubber	68081-82-3	0.00000	15.24%
Safety capacitor	0.72	Ceramic chip Y5V	$BaTiO_3$	12047-27-7	1.3244	87.6%
			$CaZrO_3$	12013-47-7		6.7%
			other 4 kinds	/		5.7%
		soldering tin	Sn	7440-31-5	0.0154	97.0%
			others	/		3.0%
		CP wire	Fe	7439-89-6	0.0392	77.5%
			Cu	7440-50-8		20.0%
			Zn	7440-31-5		2.5%
		coating materials	epoxy resin	25036-25-3	0.021	50.0%
			silica powder	14808-60-7		35.0%
			antimonous oxide	1309-64-4		5.0%
			TDE	84852-53-9		7.0%
			Pigments and additives	N/A		3.0%

N/A = Not Applicable

Material	Material / Total Weight	Name of Material	Chemical Name	Chemical Registration No./CAS No.	Material Weight (g)	Ingredients (%)
Chip capacitor	0.0032	COATER	EPOXY RESIN	25036-25-3	0.000399	13.30%
			Silicon dioxide	14808-60-7	0.000099	3.30%
		Ceramic body	$BaTiO_3$	12047-27-7	0.0012	40.00%
		SOLDER	Sn	7440-31-5	0.000537	17.90%
			Ag	7440-22-4	0.0000141	0.47%
		ELECTRODES	Ag	7440-22-4	0.000159	5.30%
			Silicon dioxide	14808-60-7	0.0000399	1.33%
		LEAD WIRE	Fe	7439-89-6	0.000021	0.70%
			Sn	7440-31-5	0.000159	5.30%
			Cu	7740-50-8	0.000543	18.10%
Optocoupler	0.93	Lead Frame	Cu (Balance)	7740-50-8	0.3162	34.00%
			Fe	7439-89-6	0.0279	3.00%
			Zn	7440-66-6	0.00279	0.30%
			Pb	7758-97-6	0.002046	0.22%
		Plating	Sn	7440-31-5	0.00186	0.20%
			Ag	7440-22-5	0.001023	0.11%
		Wire	Au	7440-57-5	0.002046	0.22%
		Chip	Silicon (Al, Au...	7440-21-3	0.00279	0.30%
			GaAs (Al, Au...	1303-00-0	0.002976	0.32%
		Mold compound	SiO_2	7440-21-3	0.558	60.00%
			Sb_2O_3	7440-36-0	0.00186	0.20%
		Silicon coating	Si (Compound)	7440-21-3	0.003255	0.35%
		Silver Epoxy	Ag	7440-22-4	0.004185	0.45%
Heat-shrinkable T bush	0.46	HEAT SHRINKBALE TUBE (BLACK)	(C_2H_4) x. $(C_4H_6O_2)$ y	24937-78-8	0.25	50.00%
			Mg (OH) 2	1309-42-8	0.2	40.00%
			P	7723-14-0	0.025	5.00%
			$C_{73}H_{108}O_{12}$	6683-19-8	0.005	1.00%
			$C_{24}H_{46}O_7$	1333-68-4	0.02	4.00%
SMT red gum	1.2	red gum	Epoxy resin	25085-99-8	0.6	50.00%
			Epoxy/amine adduct	37677-81-9	0.24	20.00%
			TALC	14807-96-6	0.24	20.00%
			Glycidyl ester	26761-45-5	0.108	9.00%
			Pigment red	7585-41-3	0.012	1.00%
Mylar	0.9	body	$C_9H_6O_4X_2$	25038-59-9	0.6003	66.70%
			SiO_2	7631-86-9	0.1197	13.30%
			TiO_2	13463-67-7	0.1197	13.30%
			$BaSO_4$	7727-43-7	0.0603	6.70%
DC Cable	6.12	Plastic	PVC	9002-86-2	3.80052	61.2%
			DPHP	26761-40-0	0.07452	1.2%
			Sb_2O_3	1327-33-9	0.03726	0.6%
			$CaCO_3$	471-34-1	0.04968	0.8%

Material	Material / Total Weight	Name of Material	Chemical Name	Chemical Registration No./CAS No.	Material Weight (g)	Ingredients (%)
DC Cable	6.12	Copper head terminal	Zn	7440-66-6	0.03726	0.60%
			Cu	7440-50-8	0.19872	3.20%
			Ni	7440-02-0	0.01242	0.20%
		The tail card internal model	PBT	26062-94-2	0.09315	1.50%
		Plug internal model	PP	9008-07-0	0.09315	1.50%
		Copper conductors	Cu	7440-50-8	1.6146	26.00%
			Sn	7440-31-5	0.07452	1.20%
		Ribbon	PVC	9002-86-2	0.07452	1.20%
			Fe	7439-89-6	0.09315	1.50%
Shrapnel	1.21	Shrapnel	C	7440-44-0	0.00047795	0.04%
			Si	7440-21-3	0.0055902	0.46%
			Mn	7439-96-5	0.0126808	1.05%
			P	7439-89-6	0.0003872	0.03%
			S	7723-14-0	0.00003267	0.00%
			Cr	7704-34-9	0.219736	18.16%
			Ni	7440-47-3	0.097405	8.05%
			Fe	7440-02-0	0.873741	72.21%
Color Circle Coils	0.475	Magnetic core	Fe_2O_3	1309-37-1	0.10224	63.90%
			ZnO	1314-13-2	0.0336	21.00%
			NiO	1313-99-1	0.0168	11%
			CuO	1317-38-0	0.0048	3.00%
			MgO	1309-48-4	0.00256	1.60%
		Stitch	Fe	7439-89-6	0.1008	84.00%
			Cu	7440-50-8	0.0114	9.50%
			Sn	7440-31-5	0.0078	6.50%
		Varnished wire	Cu	7440-50-8	0.09695	96.95%
			Fe	7439-89-6	0.00001	0.01%
			Pb	7439-92-1	0.00001	0.01%
			Sn	7440-31-5	0.00001	0.01%
			As	7440-38-2	0.00001	0.01%
			Ag	7440-22-4	0.00001	0.01%
			C_7H_8O	1319-77-3	0.001	1.00%
			C_8H_{10}	1330-20-7	0.001	1.00%
			$C_{14}H_{22}O_6$	109-16-0	0.001	1.00%
		Glue	[CH (CH_2Cl) CH_2O] n	24969-06-0	0.00205	41.00%
			$C_7H_8O_2$	9003-35-4	0.0005	10.00%
			$C_2H_4N_4$	461-58-5	0.0003	6.00%
			$C_9H_{12}N_2O$	101-42-8	0.0004	8.00%
			C_5	1333-86-4	0.00125	25.00%
			$Al_2H_2O_{12}Si_4$	1302-78-9	0.004965	99.30%
			$C_{15}H_{10}N_2O_2$	101-68-8	0.0000055	0.11%
			H_3AlO_3	21645-51-2	0.0000295	0.59%

N/A = Not Applicable

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Color Circle Coils	0.475	Pb-free solder	Sn	7440-31-5	0.004965	99.30%
			Ag	7440-22-4	0.0000055	0.11%
			Cu	7440-50-8	0.0000295	0.59%
		UV glue	UV resin	3896-11-4	0.024	60.00%
			$C_9H_{14}O_5$	55719-33-0	0.008	20.00%
			$C_9H_8N_2$	670-96-2	0.008	20.00%
		Green paint Lord	$C_{54}H_{60}O_9$	25068-38-6	0.0375	75.00%
			C_5	1333-86-4	0.0075	15.00%
			$C_6 6H_{12}O_2$	123-86-4	0.0015	3.00%
			defoamer	139-37-1	0.0035	7.00%
Case	5.39	PC resin	4-[2-(4-Methoxyphenyl)-2-propanyl] phenyl acetate hydrochloride (1:1)	13463-67-7	6.30828	97.20%
Ethyl alcohol	1	Ethyl alcohol	ethyl alcohol	64-17-5	0.995	99.50%
			acetaldehyde	75-07-0	0.0005	0.05%
			isobutanol	78-83-1	0.001	0.10%
			acetic acid	64-19-7	0.001	0.10%
			ethyl ester	139481-41-7	0.0025	0.25%
Scaling powder	2.5	Scaling powder	natural resin	8050-9-7	0.0925	3.70%
			Stearic acid resin	123-95-5	0.05075	2.03%
			synthetic resin	8050-31-5	0.05175	2.07%
			activator	111-87-5	0.01775	0.71%
			Carboxy acid	68937-72-4	0.046	1.84%
			Mixed alcohol solvent	67-63-0	2.17625	87.05%
			Anti-evaporant	15892-23-6	0.065	2.60%
Flame retardant Vulcanized silicone rubber	4.2	Heat dissipation silica gel	HPDMS	70131-67-8	1.4532	34.6%
			titanium dioxide	13463-67-7	0.126	3.0%
			calcium carbonate	471-34-1	1.092	26.0%
			aluminium hydroxide	21645-51-2	1.3188	31.4%
			ethyl acetoacetate	27858-32-8	0.126	3.0%
			MTMS	1185-55-3	0.084	2.0%
Machine cleaner	3	Machine cleaner	naphtha	8030-30-6	2.949	98.30%
			mineral wax	8002-74-2	0.039	1.30%
			others	N/A	0.012	0.40%
Tin bar	10	Tin	Tin	7440-31-5	9.97	99.70%
			Silver	7440-22-4	0.03	0.30%
Solder	5	Solder	Tin	7440-31-5	4.965	99.30%
			copper	7440-50-8	0.035	0.70%

N/A = Not Applicable

SECTION 3 - Harmfulness Overview

Health hazard:	NO
Environmental implication:	NO
Physical and chemical hazards:	NO
Special hazards:	NO

SECTION 4 - Emergency Treatment

Inhalation:	N/A
Skin exposure:	No effect, wash hands in time
Eye contact:	N/A
Ingestion:	Seek immediate medical assistance
The most important symptoms and harmful effects:	Discards can have an impact on the environment, rivers and oceans
Protection of first responders:	Follow the normal procedure

SECTION 5 - Fire Extinguishing Measures

Suitable for fire extinguishing agent:	Carbon dioxide / dry powder extinguisher
Special hazards that may occur during fire fighting:	Prevent inhalation of gas and smoke
Special extinguishing procedure:	Fire fighting personnel should be equipped with high temperature suit, suitable for extinguishing agent
Special protective equipment for fire personnel:	Follow the normal procedure

SECTION 6 - Leak Treatment

Personal notes:	N/A
Environmental considerations:	N/A
Cleaning method:	N/A

SECTION 7 - Safe Disposal Method

Disposition

Prevent contact with open flames, sparks and ignition sources

Stockpile

Store in a cool, dry and well ventilated warehouse

Keep away from fire and heat source

SECTION 8 - Exposure Prevention

Engineering control:	No need
Controls parameter:	Eight-hour daily mean admissible concentration/short-time mean admissible concentration/maximum admissible concentration: Not Applicable

Personal Safety Equipment

Breath protection:	No need
Hand protection:	No need
Eye protection:	No need
Skin and body protection:	No need
Sanitary measure:	No need

SECTION 9 - Physical and Chemical Properties

Physical	Solid	**Shape**	Rectangle
Color	Black	**Smell**	No
PH	7	**Flash Point**	N/A
Decomposition Temperature	> 500°C	**Vapor Density**	N/A
Vapor Pressure	N/A	**Solubility**	Insoluble in water

SECTION 10 - Stability and Reactivity

Stability:	Good
Possible hazardous reactions under special conditions:	High temperature incineration may contain HCl gases
Conditions to be avoided:	Avoid long-term storage in high temperature and humidity environment, and avoid overloading
Substances to be avoided:	Acid-base
Hazardous decomposed matter:	HCl, copper compound, oxycarbide
Sanitary measure:	No need

SECTION 11 - Toxicity Data

Urgent toxicity:	No
Local effect:	No
Sensitivity:	No
Slow toxicity or long-term toxicity:	No
Special effects:	High temperature incineration will have HCl gas

SECTION 12 - Ecological Data

Possible environmental impacts:
This product is not biodegradable but can be recycled in a suitable way

SECTION 13 - Disposal Method of Waste

Waste disposal method: Dispose according to the local waste related laws and regulations

SECTION 14 - Delivery Information

International transport regulations:	Transportation of general goods
United Nations number:	No

No other special means of transport

SECTION 15 - Regulatory Information

Solid waste pollution prevention and control law environmental protection act
General cargo transportation regulations

SECTION 16 - Other Information

If you need further information, please contact a Zeus sales representative.